





### DUAL OP AMP AND VOLTAGE REFERENCE

#### Description

The AP4310E is a monolithic IC specifically designed to regulate the output current and voltage levels of switching battery chargers and power supplies

The device contains two Op Amps and a 2.5V precision shunt voltage reference. Op Amp 1 is designed for voltage control with its non-inverting input internally connected to the output of the shunt regulator. Op Amp 2 is for current control with both inputs uncommitted. The IC offers the power converter designer a control solution that features increased precision with a corresponding reduction in system complexity and cost. AP4310E has more stringent reference voltage tolerance and offset.

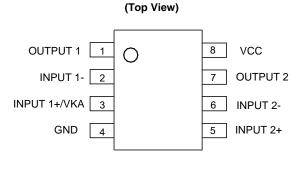
The AP4310E is available in standard package of SO-8.

#### Applications

- Battery Charger
- Switching Power Supply

and Lead-free.

### **Pin Assignments**



SO-8

### Features

#### **OP** Amp

- Input Offset Voltage: 0.5mV
- Supply Current: 75µA per OP Amp at 5.0V Supply Voltage
- Unity Gain Bandwidth:1MHz
- Output Voltage Swing: 0 to V<sub>CC</sub>-1.5V
- Power Supply Range: 3 to 36V

#### Voltage Reference

- Fixed Output Voltage Reference: 2.5V
- Reference Voltage Tolerance: ±0.4%
- Sink Current Capability: 0.05 to 80mA
- Typical Output Impedance: 0.2Ω
- Totally Lead-free & Fully RoHS Compliant (Notes1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)

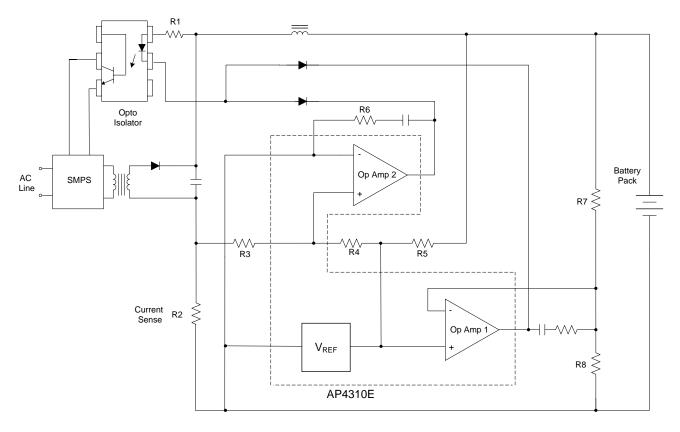
Notes:

- No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
  See http://www.diodes.com/quality/lead\_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green"
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.



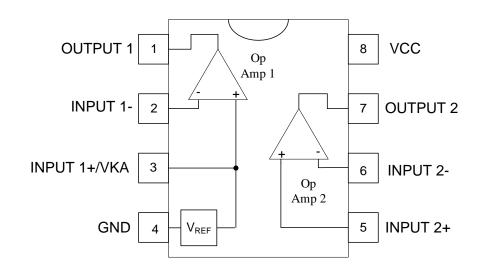


# **Typical Applications Circuit**



Application of AP4310E in a Constant Current and Constant Voltage Charger

# **Functional Block Diagram**







### Absolute Maximum Ratings (Note 4)

Symbol	Parameter	Rating	Unit
V <sub>CC</sub>	Power Supply Voltage (VCC to GND)	40	V
VIN	Op Amp1 and 2 Input Voltage Range (Pins 2, 5, 6)	-0.3 to V <sub>CC</sub> +0.3	V
VID	Op Amp 2 Input Differential Voltage (Pins 5, 6)	40	V
Ιĸ	Voltage Reference Cathode Current (Pin 3)	100	mA
PD	Power Dissipation (T <sub>A</sub> =+25°C)	500	mW
TJ	Operating Junction Temperature	+150	°C
T <sub>STG</sub>	Storage Temperature Range	-65 to +150	°C
T <sub>LEAD</sub>	Lead Temperature (Soldering 10sec)	+260	°C

Note 4: Stresses greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "Recommended Operating Conditions" is not implied. Exposure to "Absolute Maximum Ratings" for extended periods may affect device reliability.

# Recommended Operating Conditions (Note 5)

Parameter	Min	Max	Unit
Supply Voltage	3	36	V
Ambient Temperature	-40	+105	°C

Note 5: Qualified for SMD on the underside of a PCB by processing the PCB through a wave soldering operation.

### Electrical Characteristics (@V<sub>CC</sub>=5V, T<sub>A</sub>=+25°C, unless otherwise specified.)

Parameters	Conditions		Min	Тур	Max	Unit
Total Supply Current, excluding Current in	V <sub>CC</sub> =5V, no load, -40°C≤T <sub>A</sub> ≤+105°C		-	0.15	0.25	mA
Voltage Reference	V <sub>CC</sub> =30V, no load, -40°C≤T <sub>A</sub> ≤+105°C		-	0.20	0.30	
Voltage Reference Section						
	I <sub>K</sub> =10mA	T <sub>A</sub> =+25°C	2.49	2.50	2.51	v
Reference Voltage		-40°C≤T <sub>A</sub> ≤+105°C	2.48	2.50	2.52	
Reference Voltage Deviation over Full Temperature Range	I <sub>K</sub> =10mA, T <sub>A</sub> =-40°C to +105°C		-	5	24	mV
Minimum Cathode Current for Regulation	-		-	0.01	0.05	mA
Dynamic Impedance	I <sub>K</sub> =1mA to 80mA, f<1kHz		-	0.2	0.5	Ω
<b>Op Amp 1 Section</b> ( $V_{CC}$ =5V, $V_{O}$ =1.4V, $T_{A}$ =	+25°C, unless o	therwise noted.)				•
lanut Offert Veltere	T <sub>A</sub> =+25°C		-	0.5	3	mV
Input Offset Voltage	T <sub>A</sub> =-40°C to +105°C		-	_	5	
Input Offset Voltage Temperature Drift	T <sub>A</sub> =-40°C to +105°C		-	7	_	μV/°C
Input Bias Current (Inverting Input Only)	T <sub>A</sub> =+25°C		-	20	150	nA
Large Signal Voltage Gain	$V_{CC}$ =15V, R <sub>L</sub> =2k $\Omega$ , V <sub>O</sub> =1.4V to 11.4V		85	100	-	dB
Power Supply Rejection Ratio	V <sub>CC</sub> =5V to 30V		70	90	-	dB

AP4310E Document number: DS36787 Rev. 3 - 2 代理商: 锦锋科技 <u>http://www.szkingfrom.com/</u>





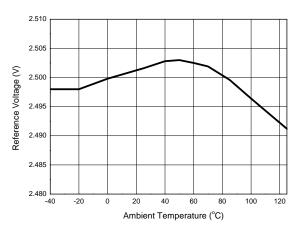
# **Electrical Characteristics** (Cont.) (@V<sub>CC</sub>=5V, T<sub>A</sub>=+25°C, unless otherwise specified.)

Parameters		Conditions	Min	Тур	Max	Unit	
Output Current	Source	$V_{CC} = 15V, V_{ID}=1V, V_{O} = 2V$	20	40	-	mA	
Output Current	Sink	$V_{CC} = 15V, V_{ID} = -1V, V_O = 2V$	8	20	-		
Output Voltage Sw	ing (High)	$V_{CC} = 30V, R_L = 10k\Omega, V_{ID} = 1V$	27	28	-	V	
Output Voltage Sw	ing (Low)	$V_{CC} = 30V, R_L = 10k\Omega, V_{ID} = -1V$ – 17		17	100	mV	
Slew Rate		$V_{CC} = 18V, R_L = 2k\Omega, A_V = 1, \\ V_{IN} = 0.5V \text{ to } 2V, C_L = 100 \text{pF}$	0.2	0.5	-	V/µs	
Unity Gain Bandwid	dth	$V_{CC}=30V,\ R_L=2k\Omega,\ C_L=100pF$	0.7	1.0	-	MHz	
Op Amp 2 Section	(V <sub>CC</sub> = 5V, V <sub>O</sub> =1.4V, 7	$T_A = +25^{\circ}$ C, unless otherwise noted.)					
		$T_A = +25^{\circ}C, V_{CC} = 5V \text{ or } 20V$	_	0.5	2		
Input Offset Voltage (Note 6)		$T_A = -40^{\circ}C$ to +105°C, $V_{CC} = 5V$ or 20V	-	_	3	mV	
Input Offset Voltage Temperature Drift		T <sub>A</sub> = -40°C to +105°C	_	7	_	µV/°C	
Input Offset Current		T <sub>A</sub> = +25°C	_	2	2 30		
Input Bias Current		T <sub>A</sub> = +25°C	_	20	20 150		
Input Voltage Range		V <sub>CC</sub> = 0 to 36V	0	_	Vcc-1.5	V	
Common Mode Re	jection Ratio	$T_A = +25^{\circ}C, V_{CM} = 0 \text{ to } 3.5V$	$A = +25^{\circ}C, V_{CM} = 0 \text{ to } 3.5V$ 70 84		_	dB	
Large Signal Voltage Gain		$V_{CC} = 15V, R_L = 2k\Omega, V_O = 1.4V \text{ to } 11.4V$	85 100 –		_	dB	
Power Supply Reje	ction Ratio	$V_{CC} = 5V$ to 30V	70	90	_	dB	
	Source	V <sub>CC</sub> = 15V, V <sub>ID</sub> = 1V, V <sub>O</sub> = 2V	', V <sub>ID</sub> = 1V, V <sub>O</sub> = 2V 20 40		_		
Output Current	Sink	V <sub>CC</sub> = 15V, V <sub>ID</sub> = -1V, V <sub>O</sub> = 2V	8	20	-	- mA	
Output Voltage Swing (High)		$V_{CC} = 30V, R_L = 10k\Omega, V_{ID} = 1V$	27	27 28 –		V	
Output Voltage Swing (Low)		$V_{CC} = 30V, R_L = 10k\Omega, V_{ID} = -1V$ – 17		100	mV		
Slew Rate		$V_{CC} = 18V, R_L = 2k\Omega, A_V = 1,$ $V_{IN} = 0.5V \text{ to } 2V, C_L = 100\text{pF}$	0.2	0.5	-	V/µs	
Unity Gain Bandwid	dth	$V_{CC} = 30V, R_L = 2k\Omega, C_L = 100pF$	0.7	1.0	– M		

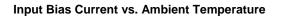
Note 6: The full temperature feature is guaranteed by design.

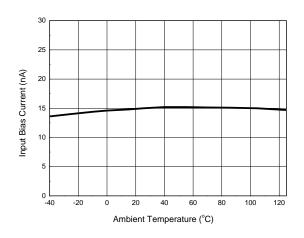


## **Performance Characteristics**

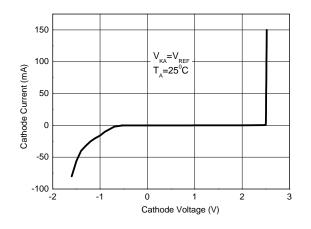


# Reference Voltage vs. Ambient Temperature

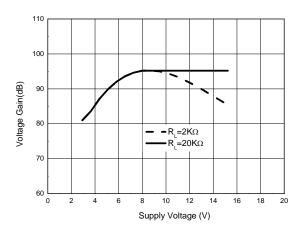




#### Cathode Current vs. Cathode Voltage



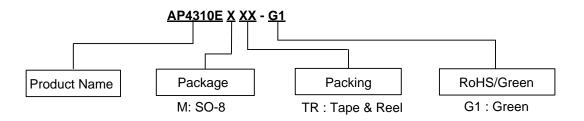
Op Amp Voltage Gain







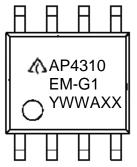
# **Ordering Information**



Package	Temperature Range	Reference Voltage	Voltage Tolerance	Part Number	Marking ID	Packing
SO-8	-40 to +105°C	2.5V	±0.4%	AP4310EMTR-G1	AP4310EM-G1	4000/Tape & Reel

# **Marking Information**





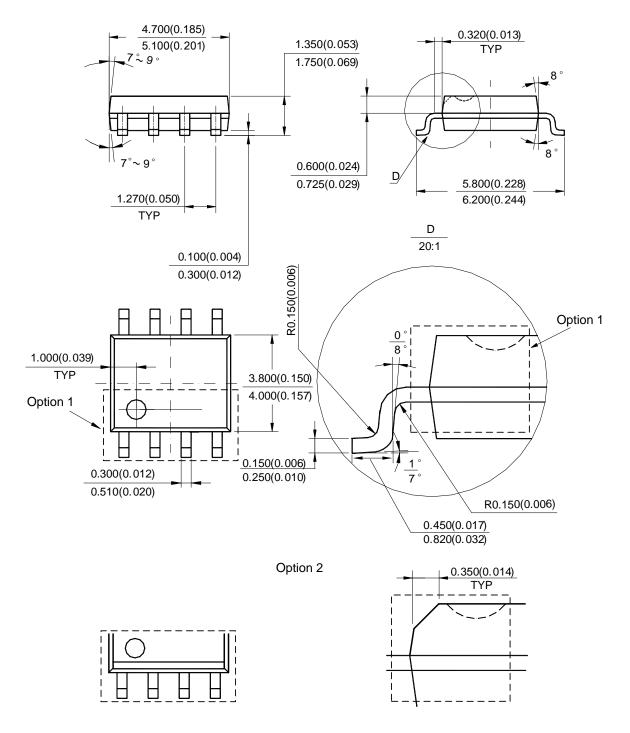
First and Second Lines: Logo and Marking ID Third Line: Date Code Y: Year WW: Work Week of Molding A: Assembly House Code XX: 7<sup>th</sup> and 8<sup>th</sup> Digits of Batch No.





### Package Outline Dimensions (All dimensions in mm (inch).)

#### (1) Package Type: SO-8



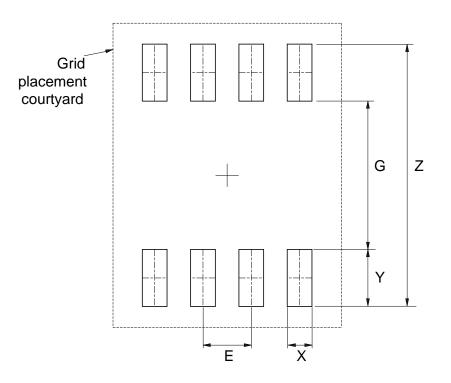
Note: Eject hole, oriented hole and mold mark is optional.





# **Suggested Pad Layout**

#### (1) Package Type: SO-8



Dimensions	Z	G	X	Y	E
	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)	(mm)/(inch)
Value	6.900/0.272	3.900/0.154	0.650/0.026	1.500/0.059	1.270/0.050





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